Low Value Flat Chip Resistors

LR Series



Features:

- Standard 2512, 2010 and 1206 sizes
- Resistance range down to $3m\Omega$
- Leach resistant plated copper wraparound terminations
- AEC-Q200 qualified
- Low thermal impedance





All Pb-free parts comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

Electrical Data

		LR(F)1206	LR(F)2010	LR(F)2512			
Power rating at 70°C	W	0.5	1	2			
Resistance range ¹	Ω	R003 to 1R0					
Resistance tolerance ¹	%	<r01: 1,="" 2,="" 5,="" 5<="" td="" ≥r01:=""></r01:>					
TCR	ppm/°C	≥R05: ±100, R025 – R047: <+500, <r025: <+900<="" td=""></r025:>					
Dielectric withstand	V	200					
Standard values		E24 and integer multiples of R001 up to R01, of R005 up to R05 and of R01 preferred					
Ambient temperature range	°C	-55 to +150					
Temperature rise at rated power	°C	40	80	90			
Pad / trace area ²	mm²	30	100	300			

Note 1. Contact factory for value – tolerance combinations outside this range.

Physical Data

Dimensions in mm and weight in mg						
	L	w	T max.	Α	Wt. nom.	
1206	3.2 ± 0.31	1.63 ± 0.2	0.8		12	
2010	5.23 ± 0.38	2.64 ± 0.25	0.84	0.6 ± 0.25	38	A
2512	6.5 ± 0.38	3.25 ± 0.25			60	L A W

Construction

Proprietary non-noble copper-based thick-film material and organic protection are screen printed on a 96% alumina substrate. The components are laser trimmed to achieve the required resistance tolerance. LR types ($>25m\Omega$) have conventional orientation with resistance element on the upper surface, whilst LRF types (≤25mΩ) have flip-chip orientation with the resistance element on the lower surface.

Terminations

The wrap-around terminations have an electroplated nickel barrier and matte tin or tin-lead finish. This ensures excellent leach resistance properties and solderability. Chips can withstand immersion in solder at 250°C for 90 seconds and are suitable for reflow or wave solder mounting processes.

Marking

The body protection and marking are resistant to all normal industrial cleaning solvents suitable for printed circuits. Chips are packed and mounted with marking side up. Parts are marked with the value code where this is up to four characters (e.g. "R025"). For five-character value codes the value in milliohms is marked, with "m" indicating decimal point position (e.g. "2m5" for value code R0025).

Processing

For reflow of flip-chip (LRF) parts, a solder paste thickness of not less than 100µm is recommended.

Note 2. Recommended minimum pad & adjacent trace area for each termination for rated dissipation on FR4 PCB.

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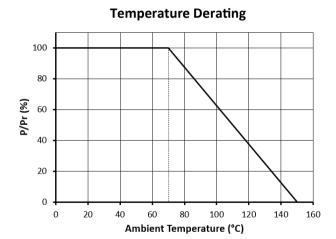
Performance Data

AEC-Q200 ¹ Table 7 Reference	Test	Method	Maximum (add R05)	Typical (@1R0)		
3	High temperature exposure	MIL-STD-202 Method 108 ±ΔR	6 0.5	0.2		
4	Temperature cycling ²	JESD22 Method JA-104 ±ΔR	6 0.25	0.1		
6	Moisture resistance	MIL-STD-202 Method 106 ±ΔR	6 0.5	0.2		
7	Biased humidity	MIL-STD-202 Method 103 ±ΔR	6 0.5	0.2		
8	Operational life (cyclic load)	MIL-STD-202 Method 108 ±ΔR	6 1	0.5		
14	Vibration	MIL-STD-202 Method 204 ±ΔR	6 0.5	0.05		
15	Resistance to solder heat	MIL-STD-202 Method 210 ±ΔR	6 0.25	0.05		
16	Thermal shock ²	MIL-STD-202 Method 107 ±ΔR	6 0.25	0.1		
18	Solderability	J-STD-002	>95% c	>95% coverage		
21	Board flex	AEC-Q200-005 ±ΔR	6 0.5	0.2		
22	Terminal strength	AEC-Q200-006 ±ΔR	6 0.25	0.1		
Short term overload		6.25 x Pr for 2s ±ΔR	6 0.5			
Low temperature storage		-65°C for 100 hours ±ΔR	6 0.5	-		
Leach resistance		Solder dip at 250°C	90s mi	90s minimum		

Note 1: Full AEC-Q200 qualification applies to ohmic values ≥R01

Note 2: Although 2010 and 2512 sizes have passed temperature cycling and thermal shock, it is in general not recommended that ceramic chips this large be used on FR4 in a severe temperature cycle environment due to the possibility of solder joint fatigue.

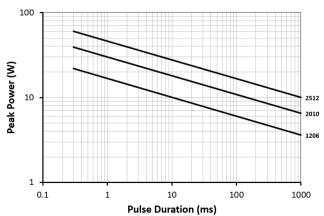
Thermal Data



Pulse Data

Continuous Pulse Performance

(mean power ≤ rated power)



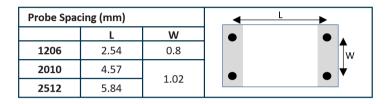
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Value Measurement

LR(F) resistors are measured using 4-terminal probes on the lower side of the chip, centred on the chip and at the spacings shown below.



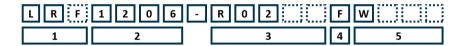
Packaging

LR(F) resistors are supplied taped and reeled as per IEC 286-3. For full details of tape and reel dimensions see: https://www.ttelectronics.com/TTElectronics/media/ProductFiles/Application-Note/PS003-Packing-of-Specialist-Chip-Resistors.pdf

Ordering Procedure

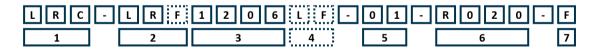
This product has two valid part numbers:

European (Welwyn) Part Number: LRF1206-R02FW (1206, 20mΩ ±1%, Pb-free)



1 Type	2 Size	3 Value	4 Tolerance	5 Termination & Packing			
LR = Conventional orientation	1206	E24 = 3-5	F = ±1%	W	Pb-free	Standard packing	
(values >R025)	2010	characters	G = ±2%	РВ	SnPb	Standard packing	
LRF = Flip-chip orientation	2512	R = ohms	J = ±5%	T1	Pb-free	1000/reel	
(values ≤R025)				T1PB	SnPb	(non-standard packing)	
				S	standard p	acking is tape & reel	
	1206 & 2010		3000/reel				
				2	2512	1800/reel	

USA (IRC) Part Number: LRC-LRF1206LF-01-R020-F (1206, $20m\Omega \pm 1\%$, Pb-free)



1 Family	2 Model	3 Size	4 Termination	5 TCR	6 Value	7 Tolerance		Packing	
LRC	LRC LR = Conventional orientation		Omit for SnPb	01 = standard	E24	F = ±1%	Standard packing is tape & reel		pe & reel
	(values >R025)	2010		(±100ppm/°C		G = ±2%	Pb-free	All sizes	1000/reel
	LRF = Flip-chip orientation	2512		values ≥R05)	R = ohms	J = ±5%	SnPb	1206 & 2010	3000/reel
	(values ≤R025)						SHED	2512	1800/reel

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

TT Electronics:

LRC-LRF1206-01-R025-F LRC-LR2010-01-R200-F LRC-LR2512-01-R220-F LRC-LRF2512-01-R012-F LRC-LRF2512-F LRC-LRF251 LR1206-01-R040-F LRC-LRF2512-01-R020-F LRC-LRF1206-01-R005-J LRC-LR1206-01-R025-JT LRC-LR2512-01-1R00-F LRC-LR1206-01-R050-F LRC-LR2010-01-R058-F LRC-LRF2512-01-R015-F LRC-LR2010-01-R033-F LRC-LR1206-01-R010-F LRC-LRF2512-01-R007-G LRC-LR2512-01-R250-F LRC-LRF1206-01-R010-F LRC-LRF1206-01-R010-J LRC-LRF1206-01-R010-G LRC-LRF2512-01-R025-F LRC-LR2512-01-R120-F LRC-LRF2512-01-R024-F LRC-LR2010-01-R220-F LRC-LRF2010-01-R012-F LRC-LR2010-01-R470-F LRC-LR2010-01-R050-F LR2010LF-01-R100-F LR2010LF-01-R200-FT LR2512LF-01-1R00-F LR2512LF-01-R030-FT LR2512LF-01-R050-F LR2512LF-01-R100-F LRF1206LF-01-R010-FT LRF2010LF-01-R025-FT LRF2512LF-01-R020-FT LRC-LR2512-01-R140-F LRC-LR2512-01-R330-F LRC-LR2512-01-R062-F LRC-LR1206-01-R080-F LRC-LR1206-01-R500-F LRC-LR1206-01-R130-FT LRC-LR1206-01-1R00-FT LRC-LR2512-01-R050-F LRC-LRF2010-01-R005-J LRC-LRF2010-01-R005-G LRC-LRF2512-01-R006-G LRC-LRF2512-01-R006-J LRC-LR2512-01-R400-F LRC-LR1206-01-R060-F LRC-LR2512-01-R200-F LRC-LR2512-01-R080-F LRC-LR1206-01-R100-F LRC-LR2512-01-R100-J LRC-LRF2512-01-R004-J LRC-LR2512-01-R100-F LRC-LR1206-01-R033-F LRC-LRF1206-01-R004-J LRC-LRF2010-01-R007-G LRC-LR2010-01-R030-F LRC-LR2010-01-R030-J LRC-LR2010-01-R332-F LRC-LR2512-01-R100-JT LRC-LRF2512-01-R009-F LRC-LRF2512-01-R009-G LRC-LRF2512-01-R005-G LRC-LRF2010-01-R025-J LRC-LRF2010-01-R025-F LRC-LRF2512-01-R005-J LRC-LR2512-01-R075-F LRC-LR2010-01-R120-F LRC-LR1206-01-R030-JT LRC-LR2512-01-R030-F LRC-LR2512-01-R500-F LRC-LR2010-01-R500-F LRC-LRF1206-01-R015-J LRC-LR2010-01-1R00-FT LRC-LRF1206-01-R015-F LRC-LR2512-01-R510-F LRC-LR1206-01-R068-FT LRC-LR2010-01-R100-F LRC-LR2010-01-R270-F LRC-LR2512-01-R056-F LRC-LRF2010-01-R010-F LRC-LR1206-01-R110-F LRC-LR1206-01-R150-F LR0-R1206-F LR0-R1206-F R150-F R150-F R150-F R150-F R150-F R150-F R150-F R150-F R150-LRF2010-01-R007-F LRC-LR2010-01-R040-F LRC-LR1206-01-R470-FT LRC-LR2010-01-R150-F LRC-LRF2512-01-R010-F LRC-LR2010-01-R075-F LRC-LRF1206-01-R003-J LRC-LRF2010-01-R018-F LRC-LR2512-01-R102-F LRC-LR2512-01-R150-F LRC-LR1206-01-R045-FT LRC-LR2512-01-R300-F LRC-LR2512-01-R027-F LRC-LR2010-01-R035-F LRC-LR2010-01-R400-FT